# 5. Pinning information

Symbol	Description	Simplified outline	Graphic symbol
T1	main terminal 1	mb	
T2	main terminal 2	ך ⊖ ך	
G	gate		sym051
T2	mounting base; main terminal 2		symos i
	T1 T2 G	T1main terminal 1T2main terminal 2Ggate	T1 main terminal 1   T2 main terminal 2   G gate

# 6. Ordering information

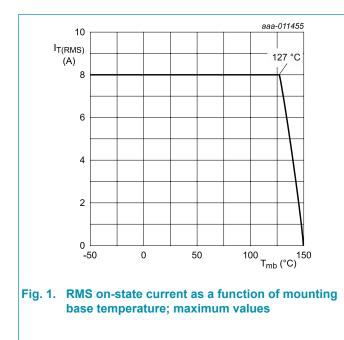
Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BTA137-600G0T	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

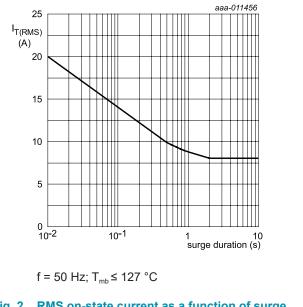
# 7. Limiting values

#### Table 4. Limiting values

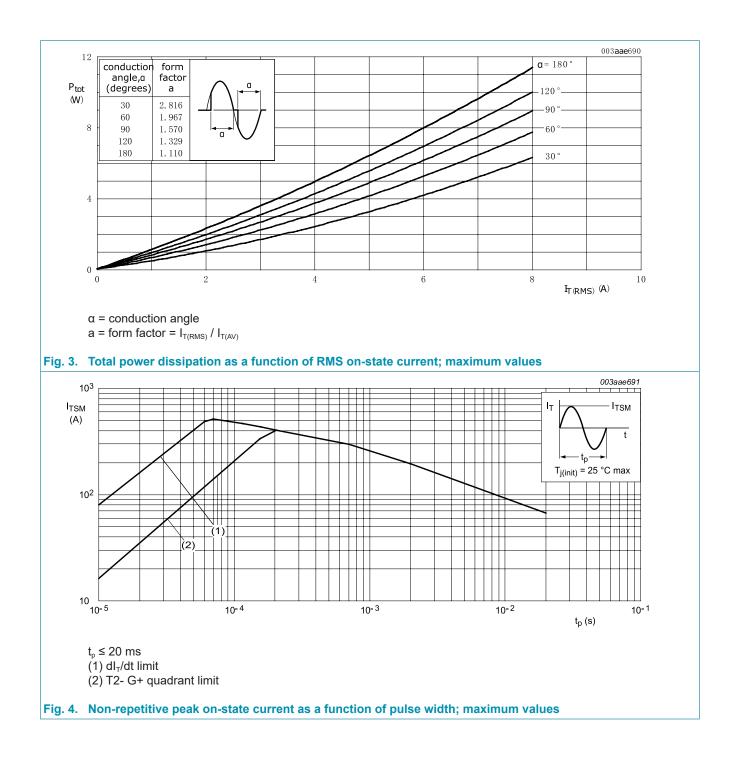
In accordance with the Absolute Maximum Rating System (IEC 60134).

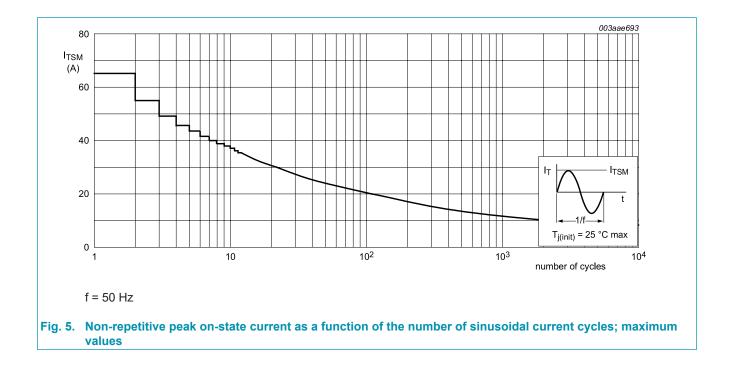
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		-	600	V
$I_{\mathrm{T}(\mathrm{RMS})}$	RMS on-state current	full sine wave; T <sub>mb</sub> ≤ 127 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	8	A
I <sub>TSM</sub>	non-repetitive peak on-state current	full sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 20 \text{ ms}$ ; Fig 4; Fig 5	-	65	A
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	71	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse	-	21	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 0.1 A; T2+ G+	-	50	A/µs
		I <sub>G</sub> = 0.1 A; T2+ G-	-	50	A/µs
		I <sub>G</sub> = 0.1 A; T2- G-	-	50	A/µs
		I <sub>G</sub> = 0.2 A; T2- G+	-	10	A/µs
I <sub>GM</sub>	peak gate current		-	2	А
$P_{GM}$	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
T <sub>stg</sub>	storage temperature		-40	150	°C
T <sub>j</sub>	junction temperature		-	150	°C





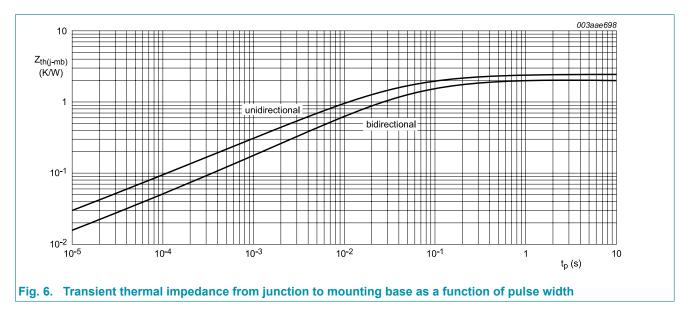






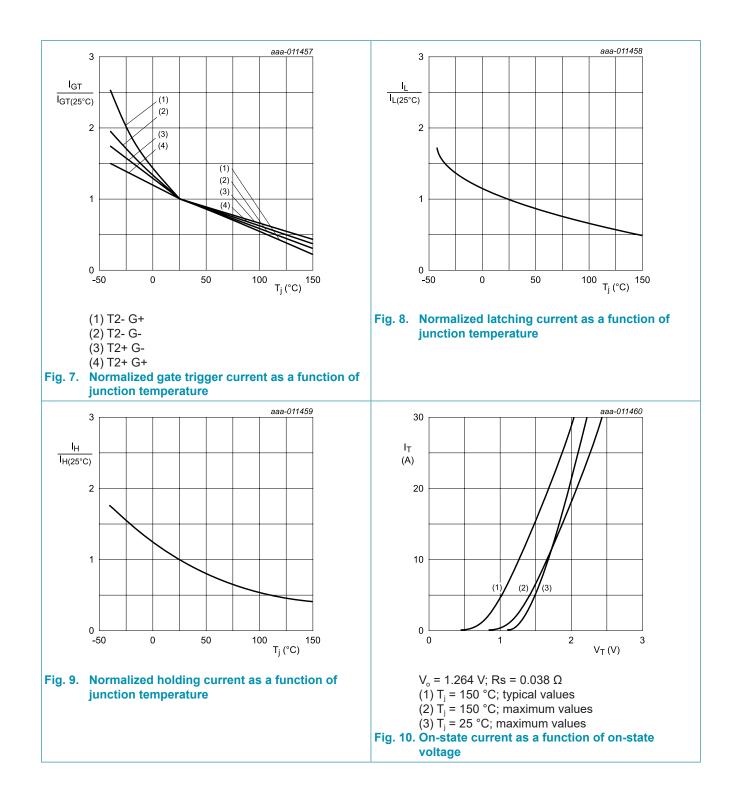
### 8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	full cycle; <u>Fig. 6</u>	-	-	2	K/W
		half cycle; <u>Fig. 6</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



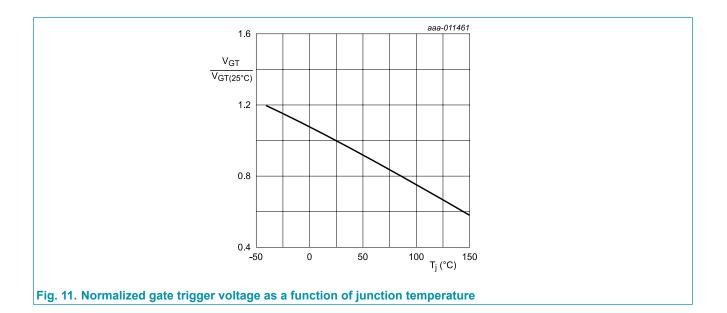
### 9. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	aracteristics			- 71-		
I <sub>GT</sub>	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ T <sub>i</sub> = 25 °C; Fig. 7	10	-	50	mA
		$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; Fig. 7	10	-	50	mA
		$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; Fig. 7	10	-	50	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G+};$ T <sub>j</sub> = 25 °C; Fig. 7	10	-	100	mA
l	latching current	$V_{D}$ = 12 V; I <sub>G</sub> = 0.1 A; T2+ G+; T <sub>j</sub> = 25 °C; Fig. 8	-	-	45	mA
		$V_{D}$ = 12 V; I <sub>G</sub> = 0.1 A; T2+ G-; T <sub>j</sub> = 25 °C; Fig. 8	-	-	60	mA
		V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.1 A; T2- G-; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-	45	mA
		$V_{D}$ = 12 V; I <sub>G</sub> = 0.1 A; T2- G+; T <sub>j</sub> = 25 °C; Fig. 8	-	-	60	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	40	mA
V <sub>T</sub>	on-state voltage	$I_{T} = 10 \text{ A}; T_{j} = 25 \text{ °C}; Fig. 10$	-	1.3	1.65	V
V <sub>GT</sub>	gate trigger voltage	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}; \text{T}_{\rm j} = 25 \text{ °C}; \text{ Fig. 11}$	-	0.7	1	V
		V <sub>D</sub> = 400V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 150 °C; <u>Fig. 11</u>	0.25	0.4	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 600 V; T <sub>j</sub> = 150 °C	-	0.4	2	mA
Dynamic	characteristics		I			
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 150 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	200	-	-	V/µs
dV <sub>com</sub> /dt	rate of change of commutating voltage	$V_{\rm D}$ = 400 V; Tj = 150 °C; dI <sub>com</sub> /dt = 3.6 A/ ms; IT = 8 A; gate open circuit	10	-	-	V/µs
gt	gate-controlled turn-on time	$I_{TM} = 12 \text{ A}; V_D = 600 \text{ V}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	μs

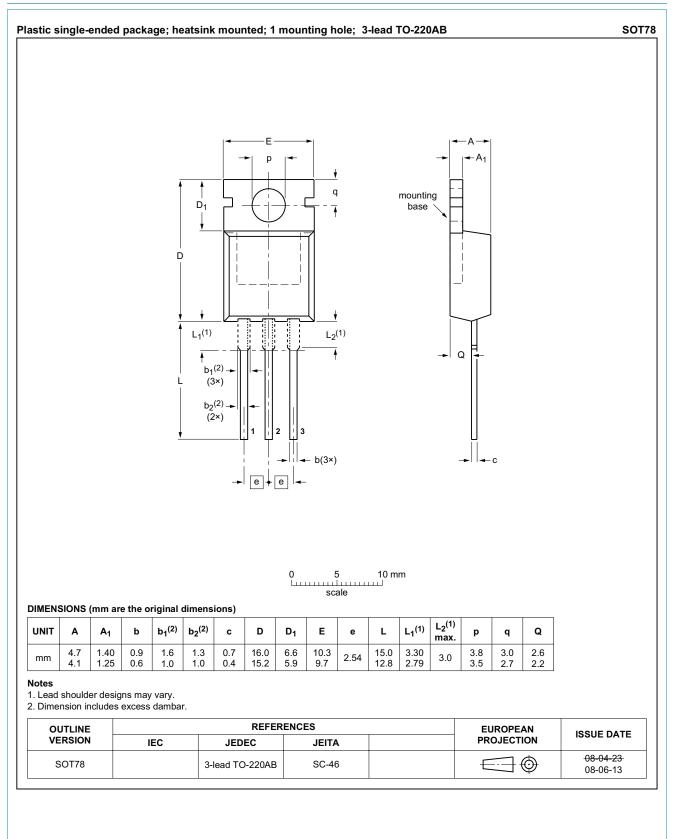


4Q Triac

BT137-600G0T



### **10. Package outline**



# 11. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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- [2] The term 'short data sheet' is explained in section "Definitions".
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### BT137-600G0T **4Q Triac**

### 12. Contents

1.	General description	.1
2.	Features and benefits	.1
3.	Applications	.1
4.	Quick reference data	.1
5.	Pinning information	.2
6.	Ordering information	.2
7.	Limiting values	.3
8.	Thermal characteristics	.6
9.	Characteristics	.7
10	Package outline	10
11.	Legal information	11
12	Contents	13

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